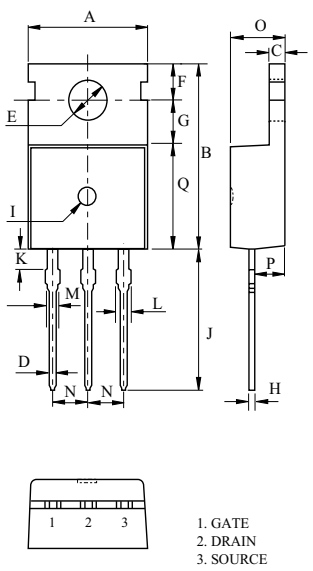
General Description

This planar stripe MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for switching mode power supplies.

FEATURES

· V_{DSS}= 600V, I_D= 2.0A
· Drain-Source ON Resistance :
$R_{DS(ON)}$=5.0 Ω @V_{GS} = 10V
· Qg(typ.) = 10.9nC



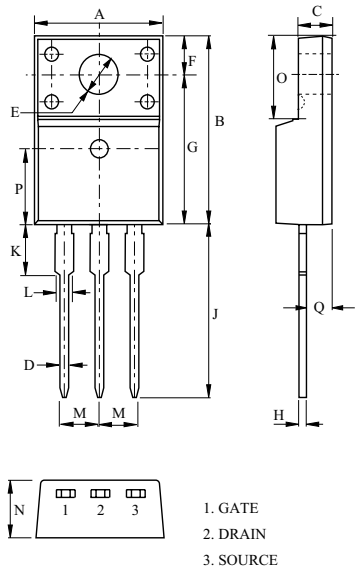
DIM	MILLIMETERS
A	9.9± 0.2
B	15.95 MAX
C	1.3+0.1/-0.05
D	0.8± 0.1
E	ø 3.6 ±0.2
F	2.8± 0.1
G	3.7
H	0.5+0.1/-0.05
I	ø 1.5
J	13.08± 0.3
K	1.46
L	1.4± 0.1
M	1.27± 0.1
N	2.54± 0.2
O	4.5± 0.2
P	2.4± 0.2
Q	9.2± 0.2

TO-220AB

MAXIMUM RATING (Tc=25℃)

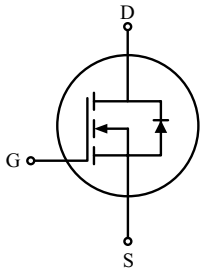
CHARACTERISTIC		SYMBOL	RATING		UNIT
			KHB2D0N60P1	KHB2D0N60F1	
Drain-Source Voltage		V_{DSS}	600		V
Gate-Source Voltage		V_{GSS}	±30		V
Drain Current	@T_C=25℃	I_D	2.0	2.0*	A
	@T_C=100℃		1.2	1.2*	
	Pulsed (Note1)	I_{DP}	8.0	8.0*	
Single Pulsed Avalanche Energy (Note 2)		E_{AS}	120		mJ
Repetitive Avalanche Energy (Note 1)		E_{AR}	5.4		mJ
Peak Diode Recovery dv/dt (Note 3)		dv/dt	5.5		V/ns
Drain Power Dissipation	Tc=25℃	P_D	54	23	W
	Derate above25℃		0.43	0.18	W/℃
Maximum Junction Temperature		T_j	150		℃
Storage Temperature Range		T_{stg}	-55～150		℃
Thermal Characteristics					
Thermal Resistance, Junction-to-Case		R_{thJC}	2.32	5.5	℃/W
Thermal Resistance, Case-to-Sink		R_{thCS}	0.5	-	℃/W
Thermal Resistance, Junction-to-Ambient		R_{thJA}	62.5	62.5	℃/W

* : Drain current limited by maximum junction temperature.



DIM	MILLIMETERS
A	10.16 ± 0.2
B	15.87 ± 0.2
C	2.54 ± 0.2
D	0.8 ±0.1
E	ø3.18 ± 0.1
F	3.3 ±0.1
G	12.57 ± 0.2
H	0.5 ±0.1
J	13.0 MAX
K	3.23 ±0.1
L	1.47 MAX
M	2.54 ± 0.2
N	4.7 ± 0.2
O	6.68 ± 0.2
P	6.5
Q	2.76 ± 0.2

TO-220IS



ELECTRICAL CHARACTERISTICS (Tc=25℃)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	I_D=250㎂, V_{GS}=0V	600	-	-	V
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_j$	I_D=250㎂, Referenced to 25℃	-	0.65	-	V/℃
Drain Cut-off Current	I_{DSS}	V_{DS}=600V, V_{GS}=0V,	-	-	10	㎂
Gate Threshold Voltage	V_{th}	V_{DS}=V_{GS}, I_D=250㎂	2.0	-	4.0	V
Gate Leakage Current	I_{GSS}	V_{GS}=±30V, V_{DS}=0V	-	-	±100	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=1.0A	-	3.8	5.0	Ω
Dynamic						
Total Gate Charge	Q_g	V_{DS}=480V, I_D=2.0A V_{GS}=10V (Note4,5)	-	10.9	12	nC
Gate-Source Charge	Q_{gs}		-	1.7	3	
Gate-Drain Charge	Q_{gd}		-	5.0	5.5	
Turn-on Delay time	$t_{d(on)}$	V_{DD}=300V R_L=150 Ω R_G=25 Ω (Note4,5)	-	-	28	ns
Turn-on Rise time	t_r		-	-	60	
Turn-off Delay time	$t_{d(off)}$		-	-	58	
Turn-off Fall time	t_f		-	-	66	
Input Capacitance	C_{iss}	V_{DS}=25V, V_{GS}=0V, f=1.0MHz	-	388	504	pF
Reverse Transfer Capacitance	C_{rss}		-	6.5	8.5	
Output Capacitance	C_{oss}		-	46	59.4	
Source-Drain Diode Ratings						
Continuous Source Current	I_S	V_{GS}<V_{th}	-	-	2.0	A
Pulsed Source Current	I_{SP}		-	-	8.0	
Diode Forward Voltage	V_{SD}	I_S=2.0A, V_{GS}=0V	-	-	1.5	V
Reverse Recovery Time	t_{rr}	I_S=2.0A, V_{GS}=0V, dIs/dt=100A/㎲	-	300	-	ns
Reverse Recovery Charge	Q_{rr}		-	1.55	-	㎌

Note 1) Repetivity rating : Pulse width limited by junction temperature.

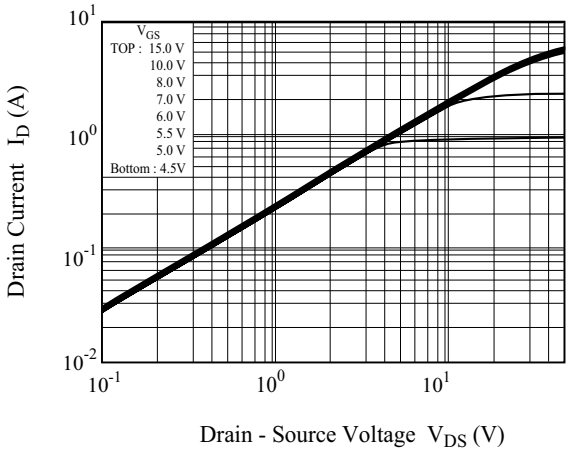
Note 2) L = 36.9mH, I_S= 2.0A, V_{DD}=50V, R_G=25 Ω, Starting T_j = 25℃.

Note 3) I_S ≤2.0A, dI/dt ≤300A/㎲, V_{DD} ≤BV_{DSS}, Starting T_j = 25℃.

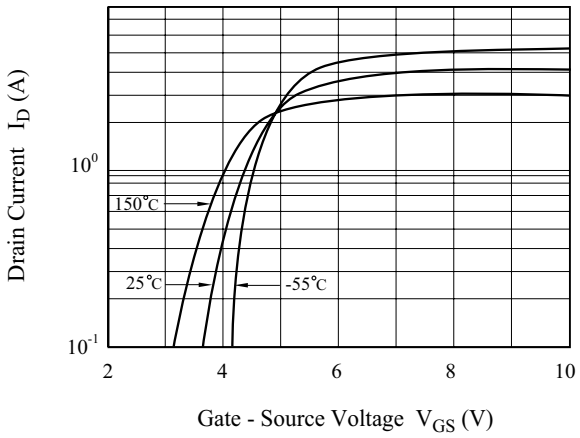
Note 4) Pulse Test : Pulse width ≤ 300㎲, Duty Cycle ≤ 2%.

Note 5) Essentially independent of operating temperature.

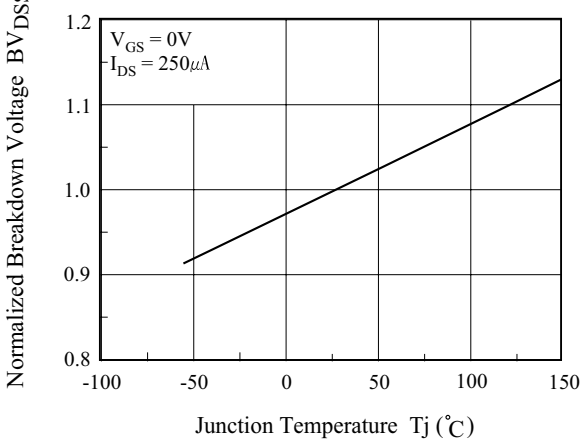
I_D - V_{DS}



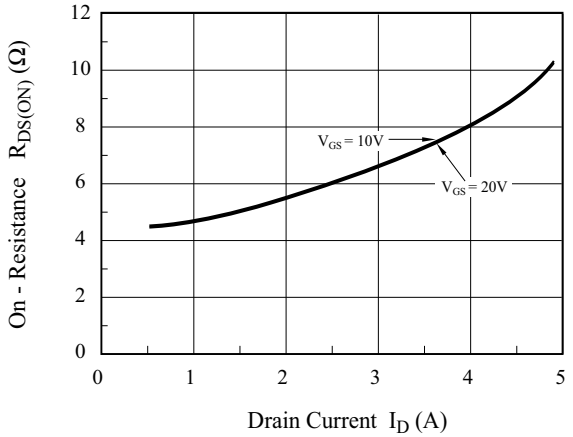
I_D - V_{GS}



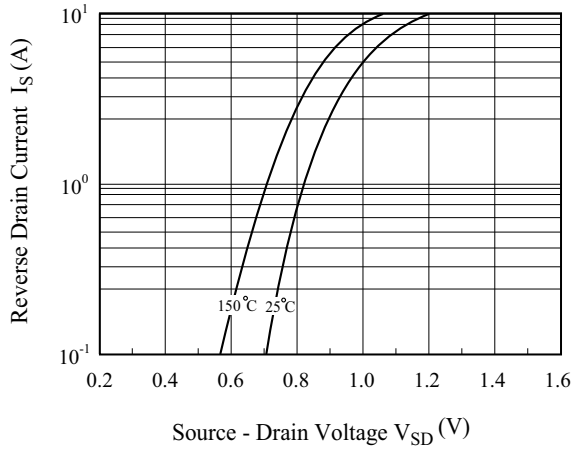
BV_{DSS} - T_j



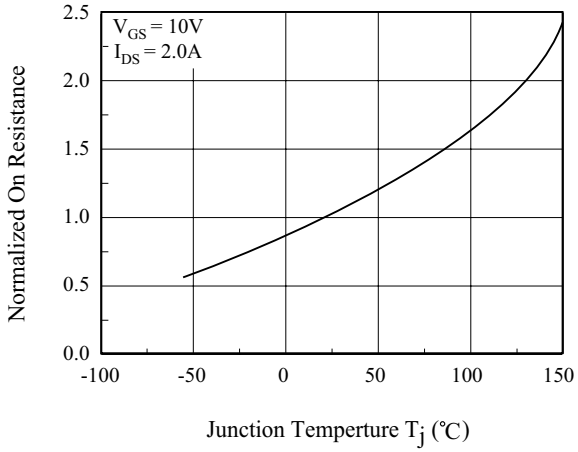
$R_{DS(ON)}$ - I_D



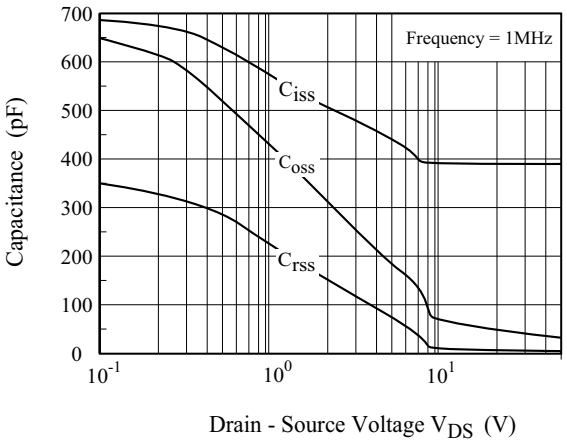
I_S - V_{SD}



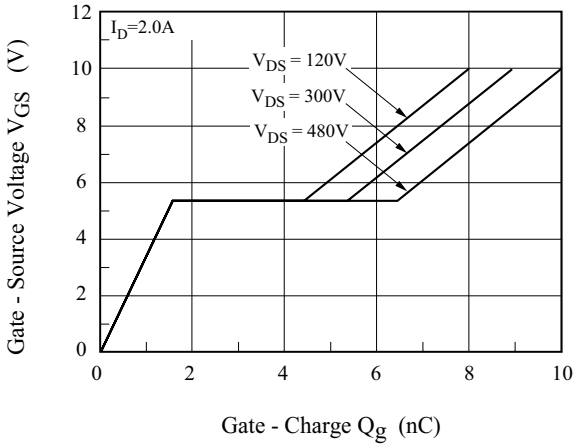
$R_{DS(ON)}$ - T_j



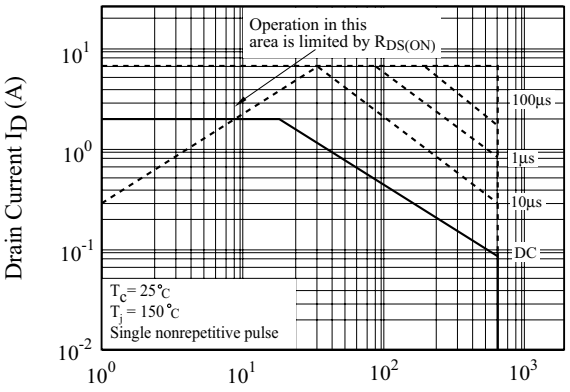
C - V_{DS}



Q_g - V_{GS}

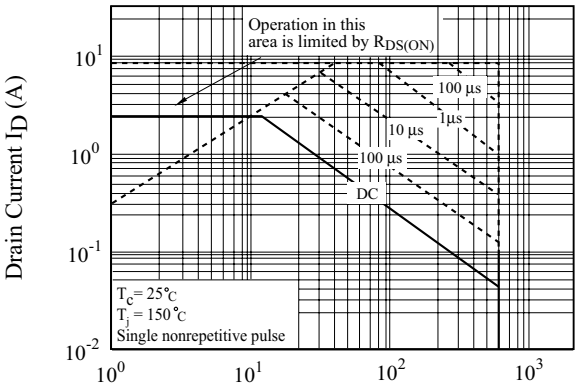


Safe Operation Area



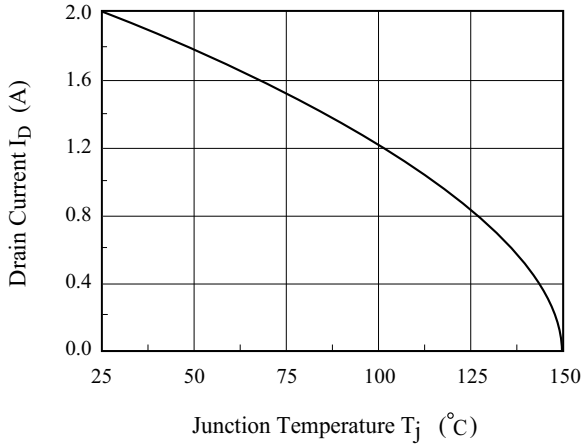
(KHB2D0N60P1)

Safe Operation Area



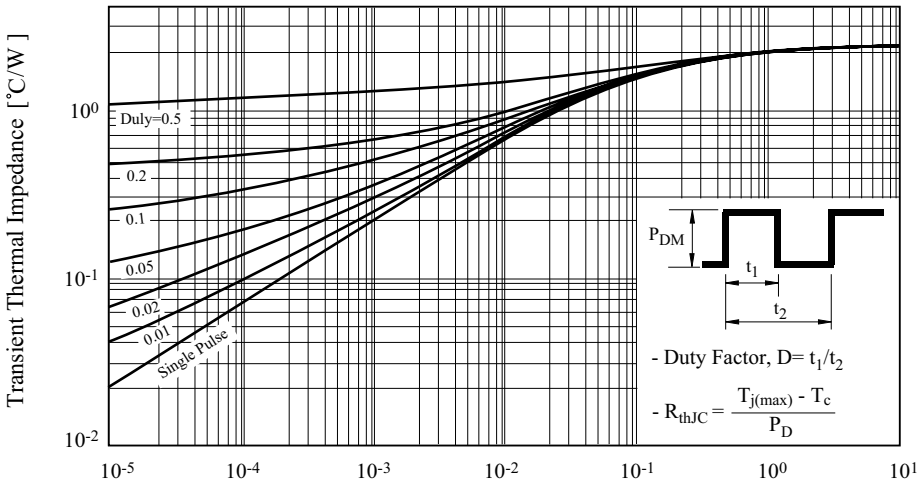
(KHB2D0N60F1)

I_D - T_j



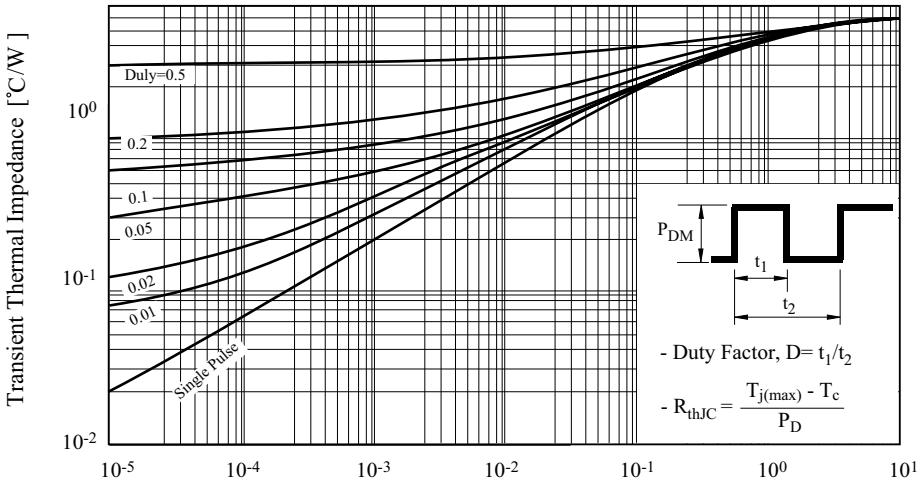
Transient Thermal Impedance

{KHB2D0N60P1}

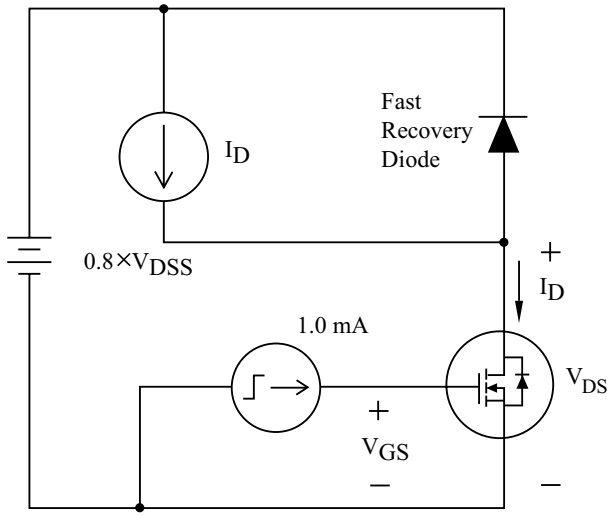


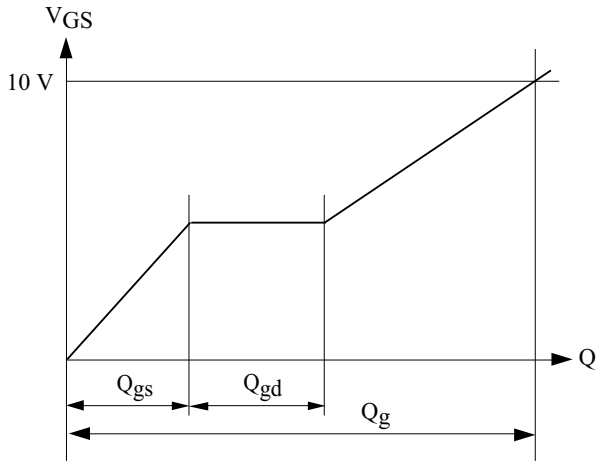
Transient Thermal Impedance

{KHB2D0N60F1}

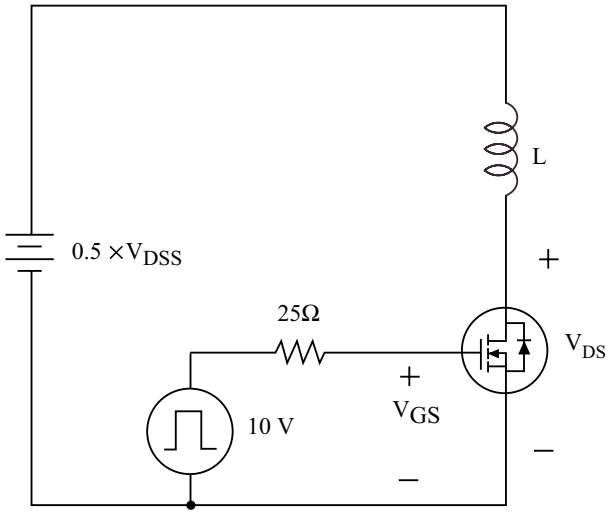


- Gate Charge

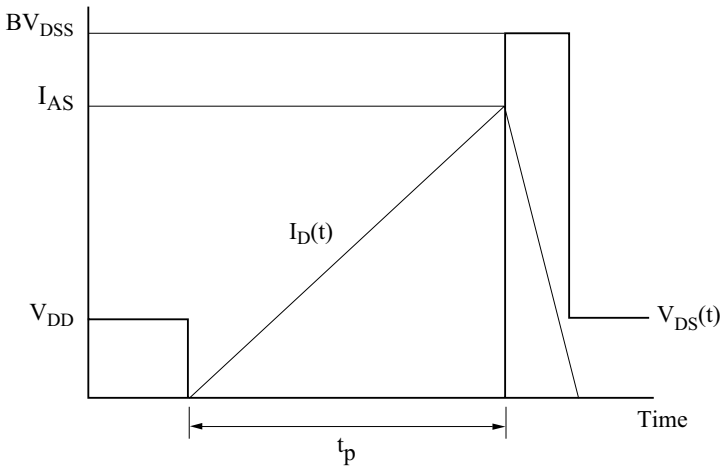




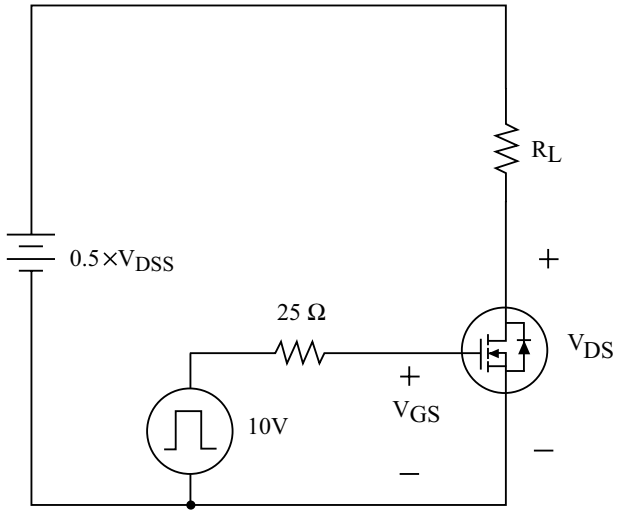
- Single Pulsed Avalanche Energy

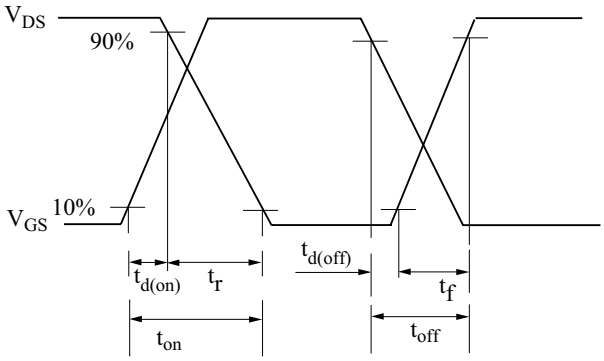


$$E_{AS}= \frac{1}{2} LI_{AS}^2 \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$



- Resistive Load Switching





- Source - Drain Diode Reverse Recovery and dv /dt